ASMT-Mx20 3W Power LED Light Source



Data Sheet







Description

3W Power LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The exposed pad design has excellent heat transfer from the package to the mother-board.

The low profile package design is suitable for a wide variety of applications especially where height is a constraint.

The package is compatible with reflow soldering process. This will give more freedom and flexibility to the light source designer.

Features

- · Available in white color
- Energy efficient
- · Exposed pad for excellent heat transfer
- · Suitable for reflow soldering process
- High current operation up to 700 mA
- · Long operation life
- · Wide viewing angle
- Silicone encapsulation
- · ESD of 2 kV
- MSL 2A

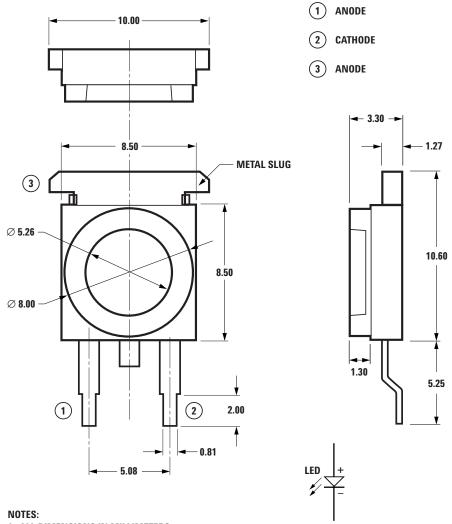
Specifications

- InGaN technology
- 4.0 V, 700 mA (max.)
- · 110 viewing angle

Applications

- · Portable (flash light, bicycle headlight)
- Reading light
- Architectural lighting
- · Garden lighting
- · Decorative lighting
- Backlighting
- · General lighting

Package Dimensions



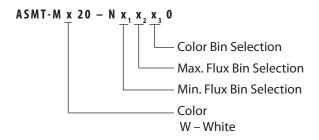
- 1. ALL DIMENSIONS IN MILLIMETERS.
- 2. TOLERANCE IS \pm 0.1 mm UNLESS OTHERWISE SPECIFIED.

Device Selection Guide at Junction Temperature $Tj = 25^{\circ}C$

		Luminous Flux, $\Phi_{\nu}^{[1][2]}$ (lm)		Test Current	Dice
Color	Part Number	Min.	Typ.	(mA)	Technology
White	ASMT-MW20	95	140	700	InGaN

- 1. Φ_{v} is the total luminous flux output as measured with an integrating sphere at 25 ms mono pulse condition.
- 2. Flux tolerance is $\pm 10\%$.

Part Numbering System



Absolute Maximum Ratings at $T_A = 25$ °C

Parameter	ASMT-Mx20	Units	
DC Forward Current	700	mA	
Peak Pulsing Current ^[1]	1000	mA	
LED Junction Temperature	120	°C	
Operating Ambient Temperature Range	-30 to +85	°C	
Storage Temperature Range	-40 to +120	°C	
Soldering Temperature	Refer to Fig	ure 5	

Note:

Optical Characteristics ($T_A = 25$ °C)

		Typical Chromaticity Coordinates		Viewing Angle 2 $\theta_{_{1/2}}^{^{[1]}}$ (Degrees)	Luminous Efficiency (lm/W)
Part Number	Color	х	у	Тур.	Тур.
ASMT-MW20	White	0.33	0.33	110	57

Notes

Electrical Characteristic ($T_{A} = 25^{\circ}C$)

	Forward Volta	ge		Thermal Resistance	
	V _F (Volts)		Reverse Voltage	$\mathbf{R}_{\odot j-ms}$ (°C/W) ^[2]	
Dice Type	Min.	Max.	V _R ^[1]	Тур.	
InGaN	3.03	4.00	Not recommended	8	

Notes

- 1. Not designed for reverse bias operation.
- 2. $R_{\omega_{j\text{-ms}}}$ is Thermal Resistance from LED junction to metal slug.

^{1.} Pulse condition duty factor = 10%, Frequency = 1 kHz.

^{1.} $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity.

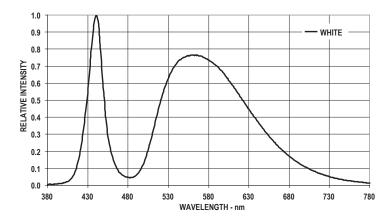


Figure 1. Relative intensity vs. wavelength

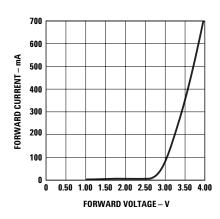


Figure 2. Forward current vs. forward voltage

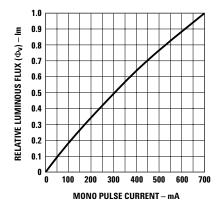


Figure 3. Relative luminous flux vs. mono pulse current

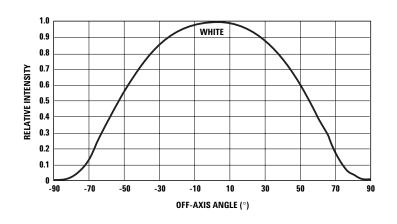


Figure 4. Radiation pattern

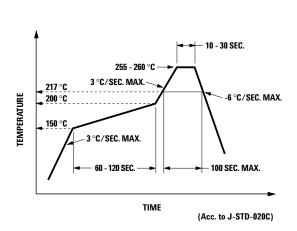


Figure 5. Recommended reflow soldering

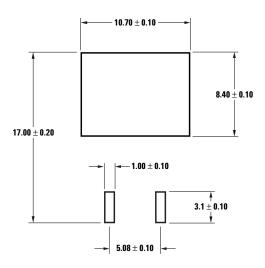


Figure 6. Recommended soldering land pattern

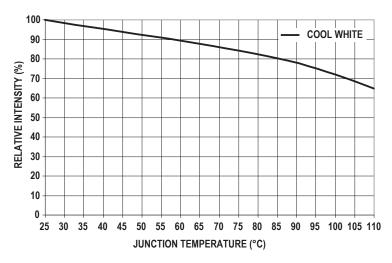


Figure 7. Relative LOP vs. junction temperature

Flux Bin Limit (for Reference Only) [X, X,]

riux bili Lilliit (for Reference only) [A ₁ A ₂]			
	Flux (lm) at 70	0 mA	
Bin	Min.	Max.	
A	5.5	7.0	
В	7.0	9.0	
С	9.0	11.5	
D	11.5	15.0	
E	15.0	19.5	
F	19.5	25.5	
G	25.5	33.0	
Н	33.0	43.0	
J	43.0	56.0	
K	56.0	73.0	
L	73.0	95.0	
M	95.0	124.0	
N	124.0	161.0	

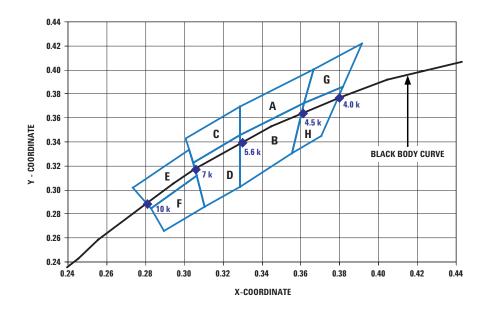
Tolerance for each bin limits is $\pm 10\%$

Color Bin Selections [**X**₃] Individual reel will contain parts from one full bin only.

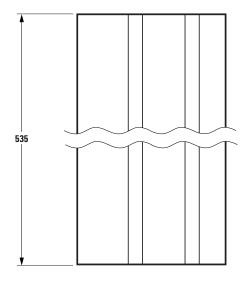
0	Full Distribution
A	A only
В	B only
С	C only
D	D only
Е	E only
F	F only
C D E F Z	A and B only
Υ	B and C only
W	C and D only
V	D and E only
U	E and F only
T S Q	F and G only
S	G and H only
	A, B and C only
Р	B, C and D only
N	C, D and E only
М	D, E and F only
L	E, F and G only
K	F, G and H only
J 1	Special Color Bin
1	A, B, C and D only
2	E, F, G and H only
3	B, C, D and E only
2 3 4 5 6	C, D, E and F only
5	A, B, C, D and E only
6	B, C, D, E, and F only

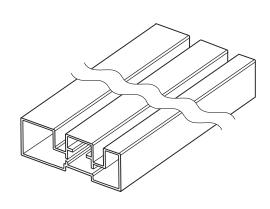
White	Color I (Chror	Limits naticity Coordi	nates)		
Bin A	X	0.367	0.362	0.329	0.329
	Y	0.400	0.372	0.345	0.369
Bin B	X	0.362	0.356	0.329	0.329
	Y	0.372	0.330	0.302	0.345
Bin C	X	0.329	0.329	0.305	0.301
	Y	0.369	0.345	0.322	0.342
Bin D	X	0.329	0.329	0.311	0.305
	Y	0.345	0.302	0.285	0.322
Bin E	X	0.303	0.307	0.283	0.274
	Y	0.333	0.311	0.284	0.301
Bin F	X	0.307	0.311	0.290	0.283
	Y	0.311	0.285	0.265	0.284
Bin G	X	0.388	0.379	0.362	0.367
	Y	0.417	0.383	0.372	0.400
Bin H	X	0.379	0.369	0.356	0.362
	Y	0.383	0.343	0.330	0.372

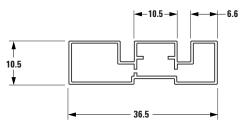
Tolerances ± 0.01



Package Tube Dimensions







Handling Precaution

The encapsulation material of the product is made of silicone for better reliability of the product. As silicone is a soft material, please do not press on the silicone or poke a sharp object onto the silicone. These might damage the product and cause premature failure. During assembly or handling, the unit should be held on the body (white epoxy).

This product is classified as moisture sensitive level 2A

When the bag is opened, parts required to mount within 672 hours of factory conditions \leq 30°C/60%, and stored at <10% RH.

Devices required bake, before mounting if:

- a) The humidity indicator card is >10% when read at 23 + 5°C
- b) The pack has been opened for more than 672 hours.

Baking recommended condition: 60 ± 5 °C for 20 hours.

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